TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHC273F,TC74VHC273FT,TC74VHC273FK

### Octal D-Type Flip-Flop with Clear

The TC74VHC273 is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

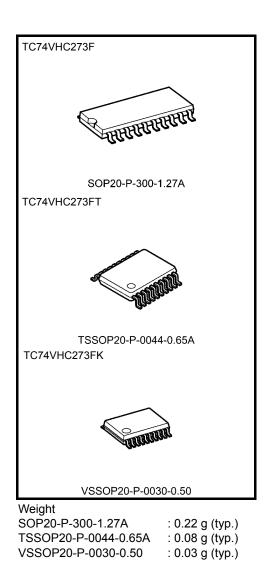
Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

When the  $\overline{\text{CLR}}$  input is held "L", the Q outputs are at a low logic level independent of the other inputs.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

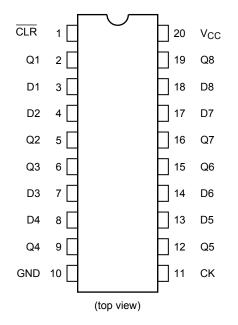
## Features

- High speed:  $f_{max} = 165 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \ \mu A \ (max)$  at  $Ta = 25^{\circ}C$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 to 5.5 V
- Low noise:  $V_{OLP} = 0.9 V (max)$
- Pin and function compatible with 74ALS273



# <u>TOSHIBA</u>

# **Pin Assignment**



# **IEC Logic Symbol**

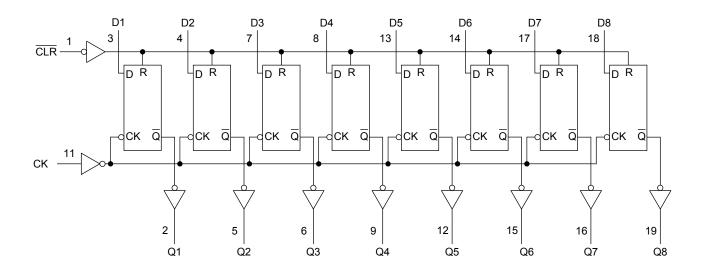
CLR (1) CLR (11)	R >C1	
D1 <u>(3)</u> D2 <u>(4)</u>	1D	(2) (5) Q2
D3 <u>(7)</u> D4 <u>(8)</u>		(6) (9) Q4
D5 <u>(13)</u> D6 <u>(14)</u>		(12) Q5 (15) Q6
D7 <u>(17)</u> D8 <u>(18)</u>		(16) Q7 (19) Q8

# Truth Table

	Inputs		Output	Function		
	D	СК	Q	FUNCTION		
L	Х	Х	L	Clear		
Н	L		L	—		
Н	Н		Н	—		
Н	Х		Q <sub>n</sub>	No Change		

X: Don't care

### System Diagram



## Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	IIК	-20	mA
Output diode current	I <sub>ок</sub>	±20	mA
DC output current	IOUT	±25	mA
DC V <sub>CC</sub> /ground current	ICC	±75	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 (V_{CC} = 3.3 $\pm$ 0.3 V)	201	
Input rise and fall time	uluv	0 to 20 (V_{CC} = 5 $\pm$ 0.5 V)	ns/V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

# **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol		Test Condition		٦	Γa = 25°(	0	Ta –40 to	a = 0 85°C	Unit
					Min	Тур.	Max	Min	Max	
High lovel input				2.0	1.50	_	_	1.50	_	
High-level input voltage	VIH	—		3.0 to 5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_	V
Low-level input				2.0	_	_	0.50	_	0.50	
voltage	VIL		—	3.0 to 5.5	—	—	V <sub>CC</sub> × 0.3	—	V <sub>CC</sub> × 0.3	V
	V <sub>OH</sub>			2.0	1.9	2.0	_	1.9	_	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	—	2.9	—	V
High-level output voltage				4.5	4.4	4.5	_	4.4	_	
Ũ			$I_{OH} = -4 \text{ mA}$	3.0	2.58	_	_	2.48	_	
			I <sub>OH</sub> = -8 mA	4.5	3.94	—	—	3.80	—	
				2.0	—	0.0	0.1		0.1	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL} = 50 \ \mu A$	3.0	—	0.0	0.1	—	0.1	
Low-level output voltage	V <sub>OL</sub>			4.5		0.0	0.1	_	0.1	V
-			$I_{OL} = 4 \text{ mA}$	3.0	—	—	0.36	—	0.44	
			I <sub>OL</sub> = 8 mA	4.5	—	_	0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_		±0.1		±1.0	μA
Quiescent supply current	ICC	V <sub>IN</sub> = V <sub>CC</sub> or	GND	5.5			4.0		40.0	μA

# Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Test Condition		Ta = 25°C		Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width (CIC)	t <sub>w (L)</sub>		$\textbf{3.3}\pm\textbf{0.3}$	_	5.5	6.5	
Minimum pulse width (CK)	t <sub>w (H)</sub>		$5.0 \pm 0.5$	—	5.0	5.0	ns
Minimum pulse width ( $\overline{CLR}$ )	<sup>t</sup> w (L)	—	$\textbf{3.3}\pm\textbf{0.3}$	_	5.0	6.0	ns
			$5.0 \pm 0.5$	—	5.0	5.0	
	ts	—	$\textbf{3.3}\pm\textbf{0.3}$	_	5.5	6.5	ns
Minimum set-up time			$5.0 \pm 0.5$	—	4.5	4.5	
Minimum hold time	t <sub>h</sub>	—	$\textbf{3.3}\pm\textbf{0.3}$	_	1.0	1.0	
Minimum hold time			$5.0 \pm 0.5$	—	1.0	1.0	ns
Minimum removal time ( CLR )			$\textbf{3.3}\pm\textbf{0.3}$	_	2.5	2.5	
	t <sub>rem</sub>	_	$5.0\pm0.5$	_	2.0	2.0	ns

#### AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Tes	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
			$3.3\pm0.3$	15	_	8.7	13.6	1.0	16.0	
Propagation delay time	t <sub>pLH</sub>		$5.5 \pm 0.5$	50	_	11.2	17.1	1.0	19.5	ns
(CK-Q)	t <sub>pHL</sub>		5.0 ± 0.5	15	_	5.8	9.0	1.0	10.5	115
、 <i>,</i>			5.0 ± 0.5	50	_	7.3	11.0	1.0	12.5	
			3.3 ± 0.3	15	_	8.9	13.6	1.0	16.0	
Propagation delay time	4	_	$3.3 \pm 0.3$	50	_	11.4	17.1	1.0	19.5	- ns
$(\overline{CLR} - Q)$	t <sub>рНL</sub>		$5.0\pm0.5$	15	_	5.2	8.5	1.0	10.0	
· · · ·				50	_	6.7	10.5	1.0	12.0	
	£		3.3 ± 0.3	15	75	120		65		
Maximum clock			5.5 ± 0.5	50	50	75	_	45		MHz
frequency	f <sub>max</sub>	_	5.0 ± 0.5	15	120	165		100		
				50	80	110		70		
	t <sub>osLH</sub>	(Note 1)	$\textbf{3.3}\pm\textbf{0.3}$	50	_		1.5	_	1.5	ns
Output to output skew	t <sub>osHL</sub>	(NOLE I)	$5.0\pm0.5$	50	_		1.0	_	1.0	115
Input capacitance	C <sub>IN</sub>					4	10		10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note 2)		31	_	_	_	pF

Note 1: Parameter guaranteed by design.

 $t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|$ 

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$  (per bit)

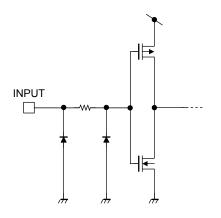
And the total  $C_{PD}$  when n pcs.of flip flop operate can be gained by the following equation:

C<sub>PD</sub> (total) = 22 + 9·n

#### Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Та		25°C	Unit
			V <sub>CC</sub> (V)	Тур.	Max	Onit
Quiet output maximum dynamic $V_{OL}$	V <sub>OLP</sub>	$C_L = 50 \text{ pF}$	5.0	0.5	0.8	V
Quiet output minimum dynamic $V_{OL}$	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.5	-0.8	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	1.5	V

# Input Equivalent Circuit

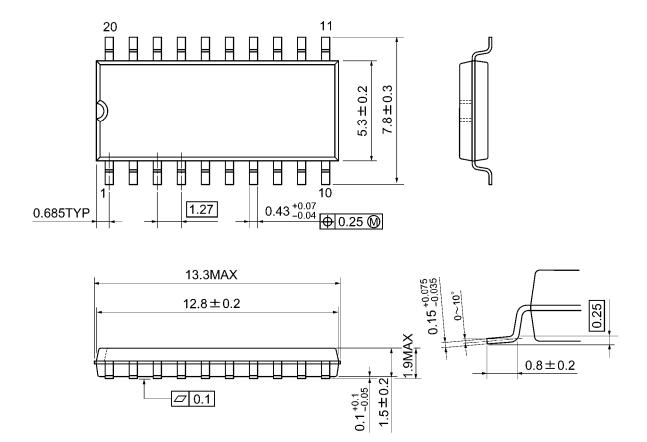




## **Package Dimensions**

SOP20-P-300-1.27A

Unit: mm



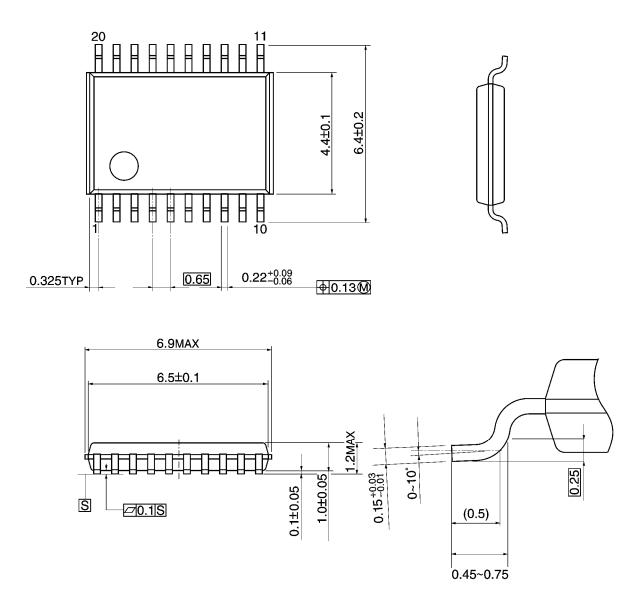
Weight: 0.22 g (typ.)

# **TOSHIBA**

# **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm



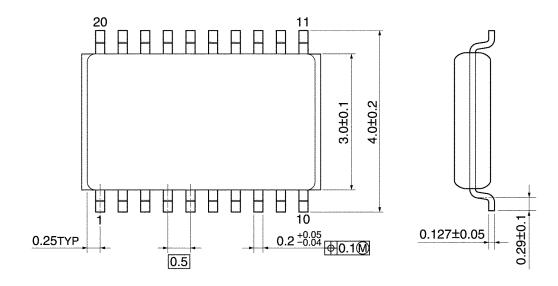
Weight: 0.08 g (typ.)

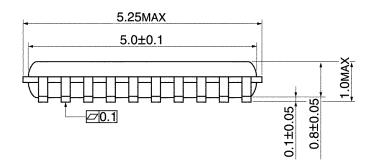


## Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm





Weight: 0.03 g (typ.)

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